

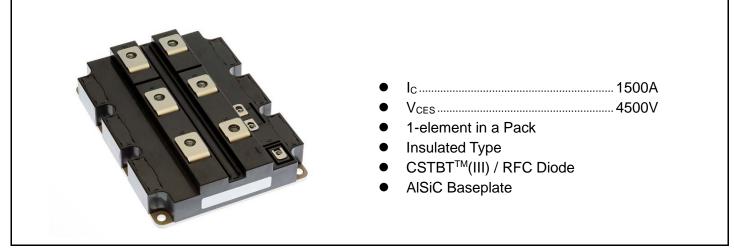
< High Voltage Insulated Gate Bipolar Transistor: HVIGBT >

CM1500HC-90XA

HIGH POWER SWITCHING USE INSULATED TYPE

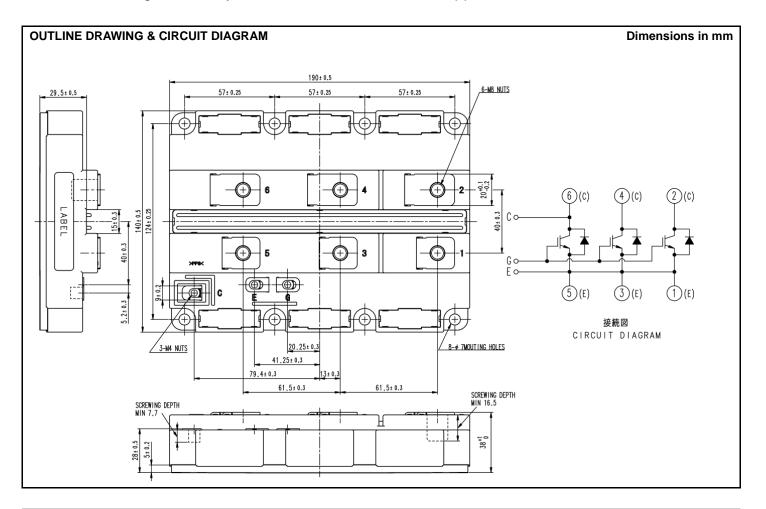
5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

CM1500HC-90XA



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V	Collector-emitter voltage	V _{GE} = 0V, T _j =+25…+150°C	4500	V
V _{CES}		$V_{GE} = 0V, T_j = -50^{\circ}C$	3900	v
V _{GES}	Gate-emitter voltage	$V_{CE} = 0V, T_j = 25^{\circ}C$	± 20	V
Ic		DC, $T_c = 105^{\circ}C$	1500	А
I _{CRM}	Collector current	Pulse (Note 1)	3000	А
IE	Emitter current (Note 2)	DC, $T_c = 90^{\circ}C$	1500	А
I _{ERM}	Emitter current (Note 2)	Pulse (Note 1)	3000	А
P _{tot}	Maximum power dissipation (Note 3)	$T_c = 25^{\circ}C$, IGBT part	14700	W
V _{iso}	Isolation voltage	RMS, sinusoidal, $f = 60Hz$, $t = 1 min$	6000	V
Ve	Partial discharge extinction voltage	RMS, sinusoidal, f = 60Hz, $Q_{PD} \le 10 \text{ pC}$	3500	V
Tj	Junction temperature		-50 ~ +150	°C
T _{jop}	Operating junction temperature		-50 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
t _{psc}	Short circuit pulse width	$V_{CC} = 3000V, V_{CE} \le V_{CES}, V_{GE} = 15V, T_j = 150^{\circ}C$	10	μS

ELECTRICAL CHARACTERISTICS

Currente e l	lterr	Conditions		Limits			Linit
Symbol	Item			Min	Тур	Max	Unit
			T _i = 25°C	_	_	10.0	
I _{CES}	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0V$	T _j = 125°C	_	10.0	_	mA
			T _i = 150°C	_	60.0	_	
V _{GE(th)}	Gate-emitter threshold voltage	V _{CE} = 10 V, I _C = 150 mA, T _i = 25°C	. ,	6.5	7.0	7.5	V
I _{GES}	Gate leakage current	$V_{GE} = V_{GES}, V_{CE} = 0V, T_i = 25^{\circ}C$		_	—	0.5	μA
Cies	Input capacitance			_	170		nF
C _{oes}	Output capacitance	$V_{CE} = 10 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$			11		nF
Cres	Reverse transfer capacitance	$T_j = 25^{\circ}C$		_	1.5		nF
Q _G	Total gate charge	V _{CC} = 2800V, I _C = 1500A, V _{GE} = ±15V		_	12.6	_	μC
			T _i = 25°C		2.20		
V _{CEsat}	Collector-emitter saturation voltage	$I_{\rm C} = 1500 {\rm A}^{(\rm Note 4)}$	T _i = 125°C		2.65		V
		V _{GE} = 15 V	T _i = 150°C	_	2.80	3.30	
	Turn-on delay time		T _i = 25°C		_		μs
t _{d(on)}			T _i = 125°C		0.55		
			T _i = 150°C	_	0.55	1.00	-
	Rise time	$V_{CC} = 2800 V$ $I_{C} = 1500 A$ $V_{GE} = \pm 15 V$ $R_{G(on)} = 2.4 \Omega$ $L_{s} = 100 \text{ nH}$ Inductive load	T _i = 25°C	_	—		μs
tr			T _i = 125°C	_	0.25	_	
			T _i = 150°C	_	0.25	0.50	
	Turn-on switching energy (Note 5)		T _i = 25°C		_		J
E _{on(10%)}			T _i = 125°C	_	6.90	_	
	per pulse		T _j = 150°C	_	7.20	_	
	Turn-on switching energy (Note 6) per pulse		T _j = 25°C	_	_	_	
Eon			T _j = 125°C	_	7.20	_	
			T _j = 150°C	_	7.50	_	
	Turn-off delay time		T _j = 25°C	_	_	_	
t _{d(off)}			T _j = 125°C	_	7.00	_	μs
			T _j = 150°C	_	7.20	10.0	
	Fall time	V _{CC} = 2800 V	T _j = 25°C	_	_		
t _f		$I_{\rm C} = 1500 {\rm A}$	T _i = 125°C	_	0.50	_	μs
		$V_{GE} = \pm 15 \text{ V}$	T _i = 150°C	_	0.50	1.20	ヿ ゙
	Turn off quitabing anargy (Note 5)	$R_{G(off)} = 30 \Omega$	T _j = 25°C	_		—	
E _{off(10%)}	rum-on switching energy	L _s = 100 nH	T _j = 125°C		5.80	—	J
	per pulse	Inductive load	T _j = 150°C		6.30	_	
	Turn off owitching oppravy (Note 6)		T _j = 25°C		—		
E _{off}	rum-on switching energy		T _j = 125°C		6.30	—	J
	per pulse		T _i = 150°C	—	6.80	—	1

Symbol	Item	Conditions		Limits			Unit	
Symbol	Item	Conditions	Conditions		Тур	Max	Unit	
V _{EC}		$I_{\rm E} = 1500 {\rm A}^{({\rm Note } 4)}$	$T_j = 25^{\circ}C$	—	2.10			
	Emitter-collector voltage (Note 2)		T _j = 125°C	_	2.50	_	V	
		$V_{GE} = 0 V$	T _j = 150°C	_	2.50	3.00		
			$T_j = 25^{\circ}C$	_	_	_		
t _{rr}	Reverse recovery time (Note 2)		T _j = 125°C	_	1.55	_	μs	
			T _j = 150°C		1.60			
			$T_j = 25^{\circ}C$	_	_	_		
I _{rr}	Reverse recovery current (Note 2)		T _j = 125°C	_	2100	_	А	
		V _{CC} = 2800 V	T _j = 150°C	_	2100	_		
			T _j = 25°C		_			
Q _{rr(10%)}	Reverse recovery charge (Note 2,7)	I _E = 1500 A	T _j = 125°C	_	2750	_	μC	
. ,		$V_{GE} = \pm 15 \text{ V}$	T _j = 150°C	_	2900	_		
		$R_{G(on)} = 2.4 \Omega$	$T_j = 25^{\circ}C$	_	_	_		
Q _{rr}	Reverse recovery charge (Note 2,6)	L _s = 100 nH	T _j = 125°C	_	2850	_	μC	
		Inductive load	T _j = 150°C	—	3000			
	Reverse recovery energy (Note 2, 5)		$T_j = 25^{\circ}C$	_	_	_		
E _{rec(10%)}	Reverse recovery energy		T _j = 125°C	_	4.10	_	J	
	per pulse		T _j = 150°C		4.50			
	Reverse recovery energy (Note 2, 6)	1	T _j = 25°C	—	_	_		
Erec	Reverse recovery energy		T _j = 125°C		4.40	_	J	
	per pulse		T _j = 150°C		4.80	_		

ELECTRICAL CHARACTERISTICS (continuation)

THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			1.1.4.14
			Min	Тур	Max	Unit
R _{th(j-c)Q}	The survey large is to see a	Junction to Case, IGBT part			8.5	K/kW
R _{th(j-c)D}	Thermal resistance	Junction to Case, FWDi part	l		13.0	K/kW
R _{th(c-s)}	Contact thermal resistance	Case to heat sink $\lambda_{grease} = 1W/m \cdot K, D_{(c-s)} = 80\mu m$		5.0	_	K/kW

MECHANICAL CHARACTERISTICS

Sympol	Item	Conditions	Limits			Linit
Symbol			Min	Тур	Max	Unit
Mt		M8 : Main terminals screw	7.0	I	19.0	N∙m
Ms	Mounting torque	M6 : Mounting screw	3.0	-	6.0	N∙m
Mt		M4 : Auxiliary terminals screw	1.0	_	3.0	N∙m
m	Mass			1.2		kg
CTI	Comparative tracking index		600			—
da	Clearance		19.5	-		mm
ds	Creepage distance		32.0	_	_	mm
L _{P CE}	Parasitic stray inductance		_	8.0		nH
R _{CC'+EE'}	Internal lead resistance	$T_c = 25 \text{ °C}$	_	0.09		mΩ

Note1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{jopmax} rating.

Note2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD_i).

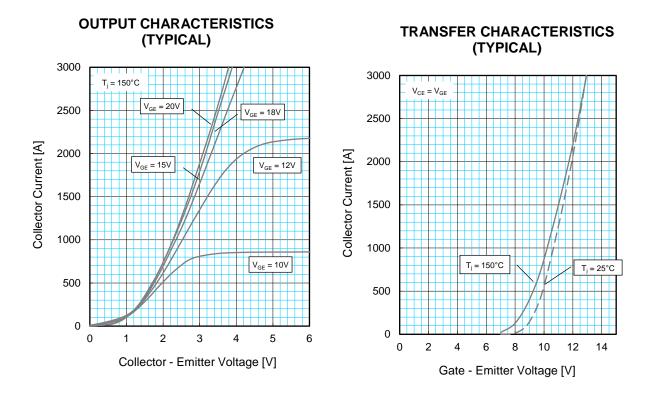
Note3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

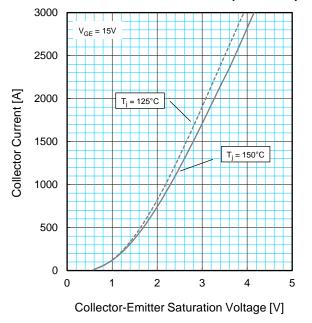
Note5. The integration range of switching energies is from $10\% V_{CE}$ to $10\% I_C(10\% I_E)$.

Note6. Definition of all items is according to IEC 60747, unless otherwise specified.

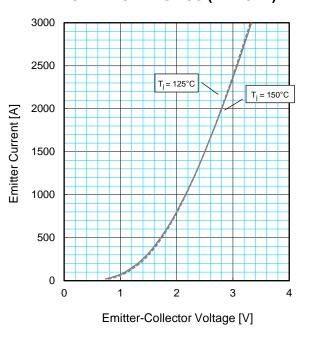
Note7. The integration range of reverse recovery charge is from $I_E = 0A$ to $10\% I_E$.

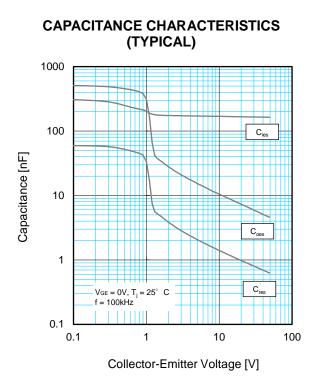


COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)

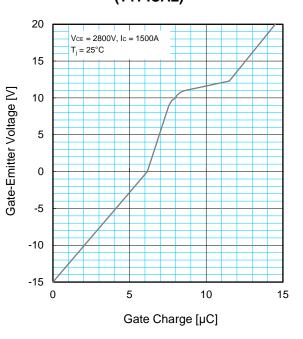


FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

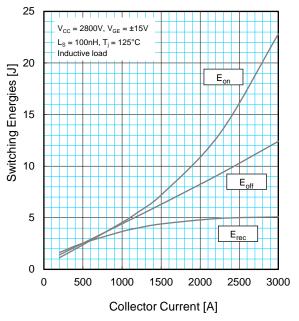




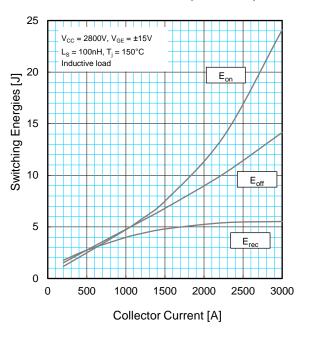
GATE CHARGE CHARACTERISTICS (TYPICAL)

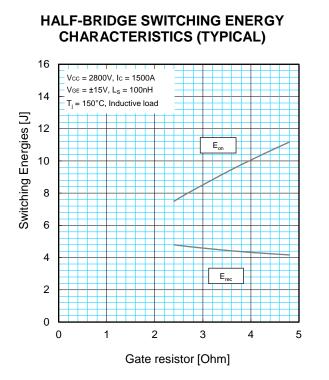


HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

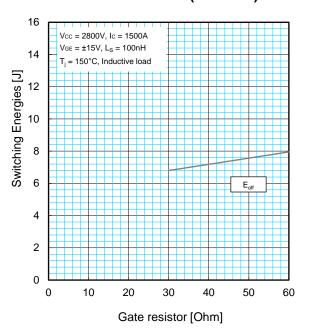


HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

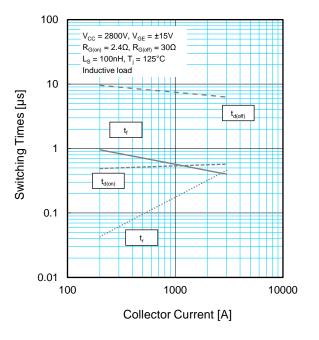




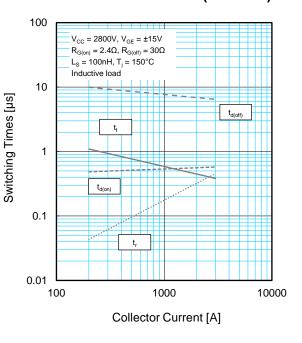
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

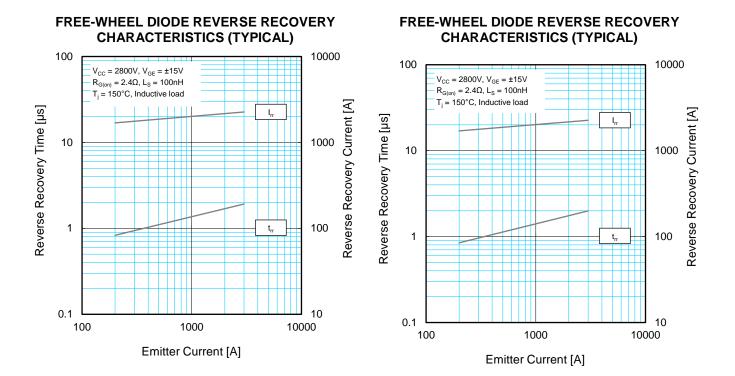


HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)

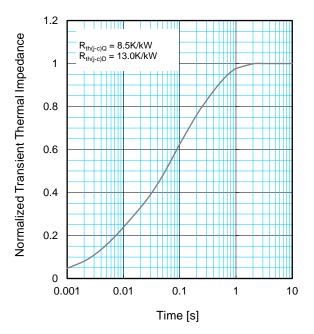


HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



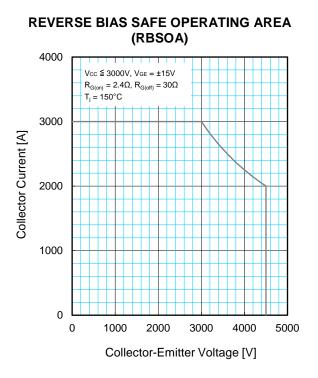


TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



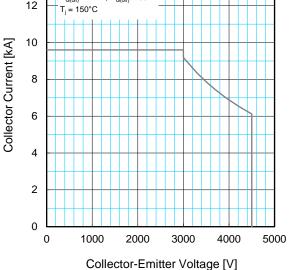
$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - exp^{\left(-\frac{t}{\tau_{i}}\right)} \right\}$

	1	2	3	4
$R_i / R_{th(j-c)}$:	0.0096	0.1893	0.4044	0.3967
$ au_{ ext{i}} ext{[sec]}$:	0.0001	0.0058	0.0602	0.3512

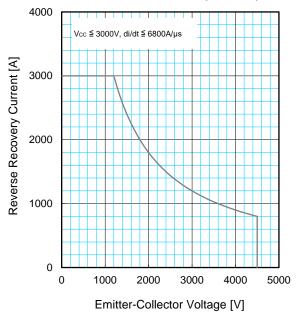


SAFE OPERATING AREA (SCSOA) 14 $V_{CC} \leq 3000V, V_{GE} = \pm 15V$ $R_{G(m)} = 2.4\Omega, R_{G(off)} = 30\Omega$ $T_j = 150^{\circ}C$

SHORT CIRCUIT



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



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